

Call for Paper

Sensors and Materials

Special Issue on Physical and Chemical Sensors

Call for Papers

The special issue on physical and chemical sensors will contain selected and extended papers from the 6th International Conference on Sensors and Electronic Instrumentation Advances (SEIA' 2020), to be held on 23–25 September 2020 in Porto, Portugal. <https://www.seia-conference.com/>

According to *Allied Market Research (AMR)*, the global market of sensors and the main types of transducers is poised to grow with an annual growth rate of 11.3%, reaching US\$241 billion in 2022. There are, however, some factors that could reduce demand, which include the threat of new entrants, the threat posed by substitutes, intense competition, lack of product differentiation, and lack of responsiveness during their use.

Scope:

- | | |
|-------------------------|---------------------|
| – Physical Sensors | – Sensing Materials |
| – Chemical Sensors | – Nanosensors |
| – Mechanical Sensors | – Photonic Sensors |
| – Optical Sensors | – Biosensors |
| – Optical Fiber Sensors | – Immunosensors |

Submission due date: November 25, 2020

Publication date (planned): First or second half of 2021

Journal website: <https://myukk.org/>

Submit to: Online Manuscript Submission System (<https://myukk-org.ssl-xserver.jp/form/>)

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(Attention)

As stated in Instructions to Authors in the Guidelines, the author(s) will be obliged to pay the publication fee upon the acceptance of the manuscript for publication (for example, JPY 99360 for 10 pages in *Sensors and Materials* format). If the quality of the English of your manuscript does not satisfy the journal standards, the authors should bear the proofreading fee (JPY 10000–15000), which will be charged with the publication fee.

If you have any questions, please feel free to contact the editorial staff at the address below.

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